

Current Mode PWM Controller With Frequency Shuffling ME8204 Series

General Description

ME8204 is a highly integrated current mode PWM control IC optimized for high performance, low standby power (<100mW) and cost effective offline flyback converter applications in $40W \sim 60W$ range. ME8204 offers complete protection coverage with self-recovery feature automatic including Cycle-by-Cycle current limiting (OCP), CS short protection, over load protection (OLP), and VDD under voltage lockout (UVLO) and latch feature including over temperature protection (OTP), over voltage (fixed or adjustable) protection(OVP). Excellent EMI performance is achieved with frequency shuffling technique together with soft switching control at the totem pole gate drive output. Tone energy at below 20KHz is minimized in the design and audio noise is eliminated during operation.

Typical Application

Offline AC/DC flyback converter for

- AC/DC adapter
- PDA power supplies
- Digital cameras and camcorder adapter
- VCR,SVR, STB, DVD&DVCD player SMPS
- Set-top box power
- Auxiliary power supply for PC and server
- Open-frame SMPS

Features

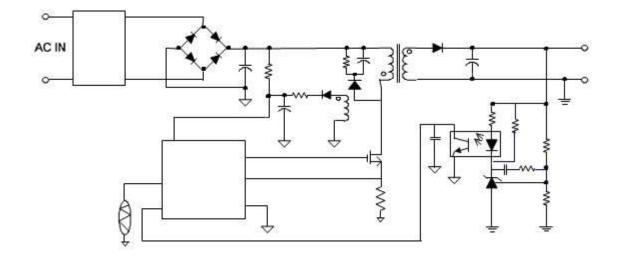
- Power on Soft Start Reducing MOSFET V_{DS} Stress
- Frequency shuffling for EMI
- •Audio Noise Free Operation
- •Extended Burst Mode Control For Improved Efficiency and Minimum Standby Power Design
- •Internal Synchronized Slope Compensation
- •Fixed 65KHz Switching Frequency (8204, 8204B)
- Fixed 100KHz Switching Frequency (8204C)
- •Good protection coverage with auto self-recovery
 - * VDD Under Voltage Lockout with Hysteresis (UVLO)
 - * Over Temperature Protection (OTP) with latch shut down(8204) or auto-recovery(8204B,8204C)
 - Cycle-by-cycle over current threshold setting for constant output power limiting over universal input voltage range
 - * Overload Protection (OLP) with auto-recovery
 - * VDD Over voltage Protection(OVP) with latch shut down(8204) or auto-recovery(8204B.8204C)
 - * Adjustable OVP through external Zener
 - * CS floating protection with auto-recovery
 - * CS short protection with auto-recovery

Package

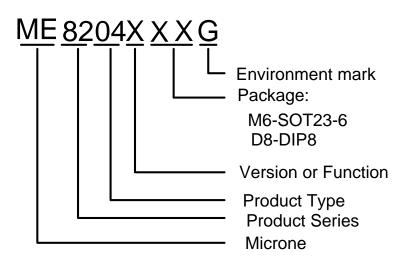
- 6-pin SOT23-6
- 8-pin DIP8



Typical Application



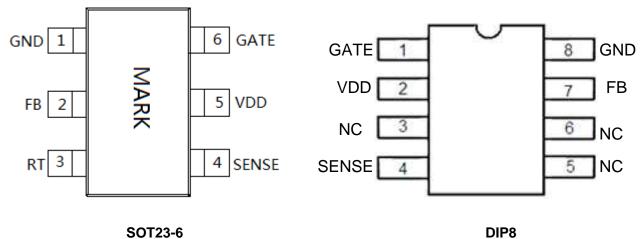
Selection Guide



Product Series	VDD OVP	ОТР	Frequency	Package	
ME8204M6G	Latch	Latch 65KHz		SOT23-6	
ME8204BM6G	Auto-recovery	ecovery Auto-recovery 65KHz		SOT23-6	
ME8204BD8G	Auto-recovery	Auto-recovery	65KHz	DIP8	
ME8204CM6G	Auto-recovery	Auto-recovery	100KHz	SOT23-6	



Pin Configuration



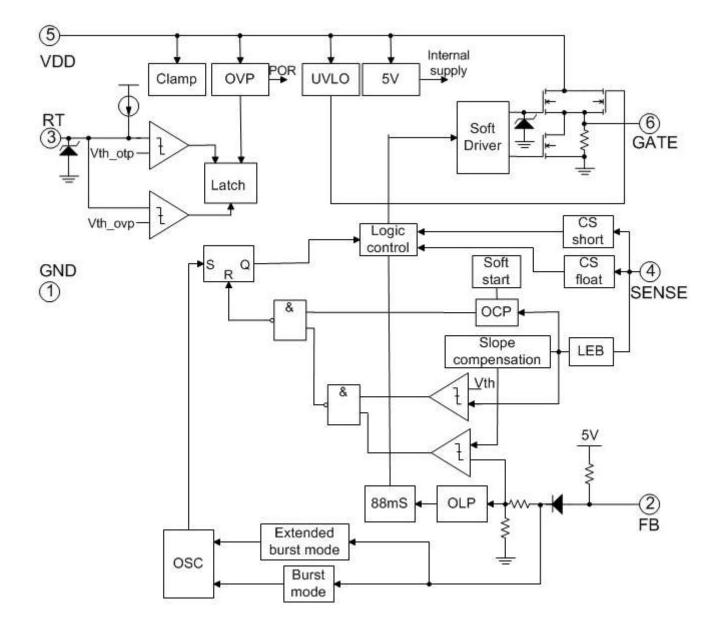
SOT23-6

PIN Assignments

Pin Num. (SOT23-6)	Pin Num. (DIP8)	Symbol	Description
1	8	GND	Ground
2	7	FB	Feedback input pin. The PWM duty cycle is determined by voltage level into this pin and the current-sense signal at PIN 3.
3		RT	Dual function PIN. Either connected through a NTC resistor to ground for over temperature shutdown/latch control or connected through Zener to VDD for adjustable over voltage protection.
4	4	SENSE	Current sense input pin. Connected to MOSFET current sensing resistor node.
5	2	VDD	Chip DC power supply pin.
6	1	GATE	Totem-pole gate drive output for the power MOSFET.
	3,5,6	NC	No connect



Block Diagram





Absolute Maximum Ratings

Parameter	Rai	Unit	
VDD/VIN DC Supply Voltage	4	0	V
VDD Zener Clamp Voltage ^{Note}	VDD_Cla	mp+0.1V	V
VDD DC Clamp Continuous Current	10		mA
V_{FB} , V_{SENSE} , V_{RI} , V_{RT} (Voltage at FB, SENSE, RI, RT to GND)	SENSE,RI,RT to GND) -0.3 to 7		V
Min/Max Operating Junction Temperature T _J		-20 to 150	
Min/Max Storage Temperature Tstg	-55 to 150		°C
R _{0JA} thermal Resistance	SOT23-6 200		°C/W
Soldering temperature and time	+260 (Recommended 10S)		°C

Caution: The absolute maximum ratings are rated values exceeding which the product could suffer physical damage.

These values must therefore not be exceeded under any conditions.

Note: VDD_Clamp has a nominal value of 32V.

Recommended Operating Condition

Parameter	Range	Unit
VDD Supply Voltage	10 to 30	V
T _A Operating Ambient Temperature	-20 to 85	°C



Electrical Characteristics($T_A = 25^{\circ}C$, VDD=16V, if not otherwise noted)

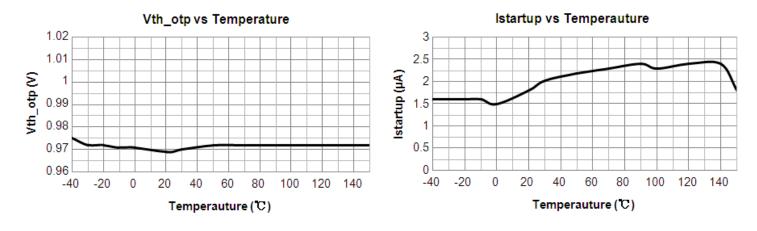
Symbol	Parameter	Parameter Test Conditions		Min	Тур.	Max	Unit
	Supply	/ Voltage (VI	DD)		•		
Startup	VDD Start up Current	VDD=11V,Measure leakage current into VDD		-	2	20	μA
		8204		-	1.8	3	mA
IVDD_Operation	Operation Current	V _{FB} =3V	8204B		1.8	3	mA
			8204C		3.3	4.5	mA
UVLO _{ON}	VDD Under Voltage Lockout Enter			8	9	10	V
UVLO _{OFF}	VDD Under Voltage Lockout Exit (Recovery)			13	14	15.5	V
V _{PULL-UP}	Pull-up PMOS active			-	13	-	V
$V_{\text{DD}_\text{Clamp}}$		$I_{VDD} = 10 \text{ m}.$	A	30	32	34	V
OVP _{ON}	VDD Over voltage protection enter	-	3V Ramp up ate clock is off	24	26	28	V
V_{LATCH_REASE}	Latch release voltage			-	5	-	V
	Feedback Ir	put Section	(FB Pin)		•		
AV _{CS}	PWM Input Gain $\Delta V_{FB} / \Delta V_{CS}$			-	2	-	V/V
Maximum duty cycle	Max duty cycle	V _{DD} =16V,V _{FB} =3V, V _{CS} =0V		75	80	85	%
V _{FB_Open}	V _{FB} Open Loop Voltage			3.9	4.2	-	V
FB_Short	FB pin short circuit current	Short FB pin to GND, measure current		-	0.3	-	mA
V_{REF} GREEN	The threshold enter green mode			-	1.4	-	V
$V_{REF_BURST_H}$	The threshold exit burst mode			-	0.675	-	V
$V_{REF_BURST_L}$	The threshold enter burst mode			-	0.575	-	V
V_{TH_PL}	Power Limiting FB Threshold Voltage			-	3.7	-	V
T_{D_PL}	Power limiting Debounce Time			80	88	96	mS
Z_{FB_IN}	Input Impedance			-	4	-	KΩ
	Current Ser	nse Input(Se	nse Pin)				
Soft start time				-	4	-	mS
T_ blanking	Leading edge blanking time			-	220	-	nS
$Z_{\text{SENSE_IN}}$	Input Impedance			-	40	-	KΩ
T_{D_OC}	Over Current Detection and Control Delay	From over current occurs till the gate drive output start to turn off		-	120	-	nS
V_{TH_OC}	Internal current limiting threshold voltage	FB=3.3V		-	0.875	-	V



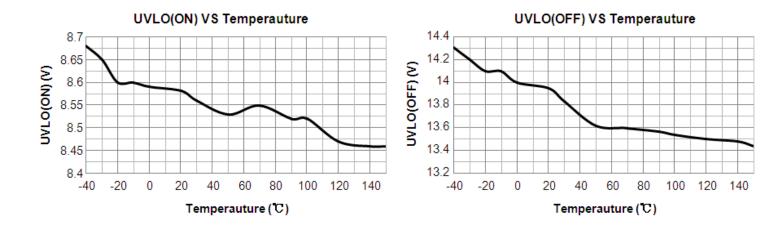
ME8204

V _{OCP_CLAMPER}	CS voltage clamper			-	0.95	-	V	
Oscillator								
		VDD=16V,	8204	60	65	70	KHz	
Fosc	Normal Oscillation Frequency	FB=3V,CS=0	8204B	60	65	70	KHz	
		V	8204C	95	100	105	KHz	
Δf_OSC	Frequency jittering			-	±4	-	%	
∆f_ Temp	Frequency Temperature Stability	-20°C to 100 °C)	-	1	-	%	
			8204	-	32	-	Hz	
F_ shuffling	Shuffling frequency		8204B		32	-	Hz	
			8204C		50	-	Hz	
Δf_VDD	Frequency Voltage Stability			-	1	-	%	
	Burst Mode Base Frequency		8204	-	22	-	KHz	
F_ Burst			8204B		22	-	KHz	
			8204C		32	-	KHz	
	Gate	Drive Output						
V _{OL}	Output Low Level	$V_{DD} = 16V, I_{O} = 5$	mA	-	-	1	V	
V _{OH}	Output High Level	V _{DD} =16V,lo = 20 mA		6	-	-	V	
V_ Clamp	Output Clamp Voltage			-	12	-	V	
T_ r	Output Rising Time $1V$ \sim 12V	$C_{L} = 1000 pF$		-	175	-	nS	
T_f	Output Falling Time 12V~1V	$C_L = 500 pF$		-	85	-	nS	
	Over Temperature Protection							
I _{RT}	Output current of RT pin			95	100	105	μA	
V _{OTP}	Threshold voltage for OTP			0.95	1	1.05	V	
V _{OTP_FL}	Float voltage at RT pin			-	2.3	-	V	
T _{D_OTP}	OTP De-bounce time			-	32	-	Cycle	
V _{RT_OVP}	RT Pin open voltage			-	4	-	V	

Typical performance characteristics







Operation Description

The ME8204 is a low power off-line SMPS Switcher optimized for off-line flyback converter applications in 40W~60W power range. The 'Extended burst mode' control greatly reduces the standby power consumption and helps the design easily to meet the international power conservation requirements.

•Startup Current and Start up Control

Startup current of ME8204 is designed to be very low so that VDD could be charged up above UVLO threshold level and device starts up quickly. A large value startup resistor can therefore be used to minimize the power loss yet provides reliable startup in application. For a typical AC/DC adaptor with universal input range design, a 2 M Ω , 1/8 W startup resistor could be used together with a VDD capacitor to provide a fast startup and low power dissipation design solution.

Operating Current

The Operating current of ME8204 is low at 1.8mA. Good efficiency is achieved with ME8204 low operating current together with extended burst mode control features.

•Frequency shuffling for EMI improvement

The frequency Shuffling/jittering (switching frequency modulation) is implemented in ME8204. oscillation The frequency is modulated with a random source so that the tone energy is spread out. The spread spectrum minimizes the conduction band EMI therefore and reduces system design challenge.



•Extended Burst Mode Operation

At zero load or light load condition, majority of the power dissipation in a switching mode power supply is from switching loss on the MOSFET transistor, the core loss of the transformer and the loss on the snubber circuit. The magnitude of power loss is in proportion to the switching frequency. Lower switching frequency leads to the reduction on the power loss and thus conserves the energy.

The switching frequency is internally adjusted at no load or light load condition. The switch frequency reduces at light/no load condition to improve the conversion efficiency. At light load or no load condition, the FB input drops below burst mode threshold level and device enters Burst Mode control. The Gate drive output switches only when VDD voltage drops below a preset level and FB input is active to output an on state. Otherwise the gate drive remains at off state to minimize the switching loss and reduces the standby power consumption to the greatest extend. The nature of high frequency switching also reduces the audio noise at any loading conditions.

Oscillator Operation

The switching frequency of ME8204 is internally fixed at 65KHz. No external frequency setting components are required for PCB design simplification.

•Current Sensing and Leading Edge Blanking

Cycle-by-Cycle current limiting is offered in ME8204 current mode PWM control. The switch current is detected by a sense resistor into the sense pin. An internal leading edge blanking circuit chops off the sense voltage spike at initial MOSFET on state due to Snubber diode reverse recovery so that the external RC filtering on sense input is no longer required. The current limiting comparator is disabled and thus cannot turn off the external MOSFET during the blanking period. PWM duty cycle is determined by the current sense input voltage and the FB input voltage.

Internal Synchronized Slope Compensation

Built-in slope compensation circuit adds voltage ramp onto the current sense input voltage for PWM generation. This greatly improves the close loop stability at CCM and prevents the sub-harmonic oscillation and thus reduces the output ripple voltage.

Gate Drive

The power MOSFET is driven by a dedicated gate driver for power switch control. Too weak the gate drive strength results in higher conduction and switch loss of MOSFET while too strong gate drive output compromises the EMI. A good trade-off is achieved through the built-in totem pole gate design with right output strength and dead time control. The low idle loss and good EMI system design is easier to achieve with this dedicated control scheme.



•Over Temperature Protection

A NTC resistor in series with a regular resistor should connect between RT and GND for temperature sensing and protection.NTC resistor value becomes lower when the ambient temperature rises. With the fixed internal current I_{RT} flowing through the resistors, the voltage at RT pin becomes lower at high temperature. The internal OTP circuit is triggered and shutdown the MOSFET when the sensed input voltage is lower than V_{TH_OTP} .

Protection Controls

Good power supply system reliability is achieved with its rich protection features including Cycle-by-Cycle current limiting (OCP), Over Load Protection (OLP), CS short protection, CS floating and features including over protection, latch temperature protection (OTP), fixed or adjustable over voltage protection (OVP), and Under Voltage Lockout on VDD (UVLO).

The OCP is line voltage compensated to achieve constant output power limit over the universal input voltage range.

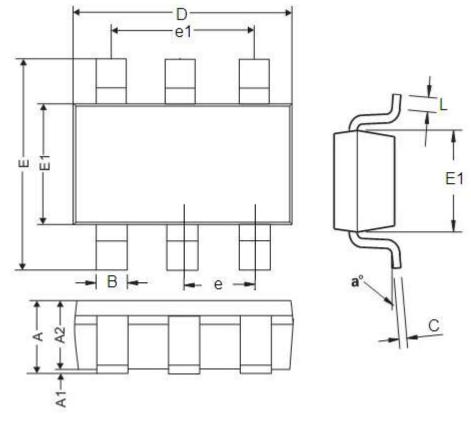
At overload condition, When FB input exceeds power limit threshold value for more than T_{D_PL} , control circuit reacts to shut down the output power MOSFET. Similarly, control circuit reacts to shut down the switcher. Switcher restarts when VDD voltage drops below UVLO limit. For latch mode, control circuit shutdowns (latch) the power MOSFET when an

Over Temperature condition or Over Voltage condition is detected until VDD drops below 5V (Latch release voltage), and device enters power on restart-up sequence thereafter.



Packaging Information

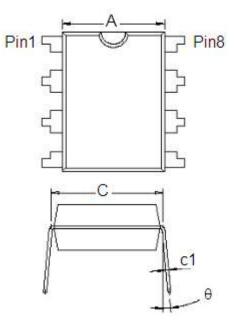
• Package type: SOT23-6

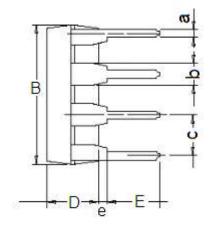


DIM	Millimeters		Inches		
	Min	Мах	Min	Max	
A	0.9	1.45	0.0354	0.0570	
A1	0	0.15	0	0.0059	
A2	0.9	1.3	0.0354	0.0511	
В	0.2	0.5	0.0078	0.0196	
С	0.09	0.26	0.0035	0.0102	
D	2.7	3.10	0.1062	0.1220	
E	2.2	3.2	0.0866	0.1181	
E1	1.30	1.80	0.0511	0.0708	
е	0.95REF		0.0374REF		
e1	1.90	REF	0.0748REF		
L	0.10	0.60	0.0039	0.0236	
a ⁰	00	30 ⁰	00	30 ⁰	



• Package type: DIP8





DIM	Millimeters		Inches		
	Min	Max	Min	Max	
A	6.200	6.600	0.244	0.260	
В	9.000	9.400	0.354	0.370	
С	7.620	(Тур.)	0.300(Тур.)		
D	3.200	3.600	0.126	0.142	
E	3.000	3.600	0.118	0.142	
а	0.360	0.560	0.014	0.022	
b	1.524	(Тур.)	0.060(Typ.)		
С	2.54(Тур.)		0.100(Тур.)		
c1	0.204	0.360	0.008	0.014	
е	0.510(Min)		0.020	(Min)	
θ	00	15 ⁰	00	150	



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